National **S**emiconductor

MM54HC107/MM74HC107
Dual J-K Flip-Flops with Clear

General Description

These J-K Flip-Flops utilize advanced silicon-gate CMOS technology to achieve the high noise immunity and low power dissipation of standard CMOS integrated circuits. These devices can drive 10 LS-TTL loads.

These flip-flops are edge sensitive to the clock input and change state on the negative going transition of the clock pulse. Each one has independent J, K, CLOCK, and CLEAR inputs and Q and $\overline{Q}$ outputs. CLEAR is independent of the clock and accomplished by a low level on the input.

The 54HC/74HC logic family is functionally as well as pin-out compatible with the standard 54LS/74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical propagation delay: 16 ns
- Wide operating voltage range: 2–6V
- Low input current: 1 μA maximum
- Low quiescent current: 40 μA (74HC series)
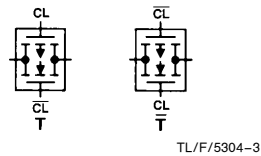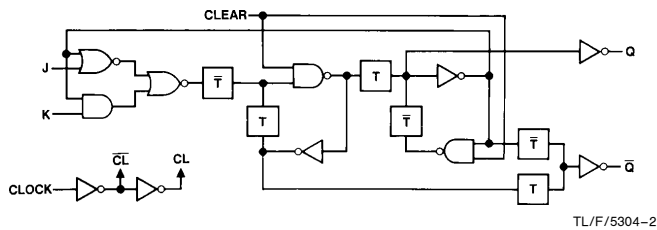- High output drive: 10 LS-TTL loads

Connection Diagram

Dual-In-Line Package

TL/F/5304–1
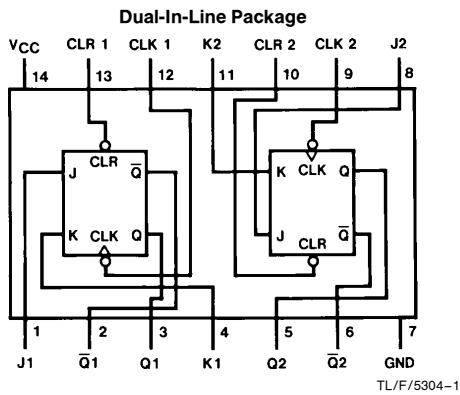
Order Number MM54HC107 or MM74HC107

Truth Table

Inputs				Outputs	
CLR	CLK	J	K	Q	$\overline{Q}$
L	X	X	X	L	H
H	↓	L	L	Q0	$\overline{Q}$0
H	↓	H	L	H	L
H	↓	L	H	L	H
H	↓	H	H	TOGGLE	
H	H	X	X	Q0	$\overline{Q}$0

Logic Diagram

TL/F/5304–2

TL/F/5304–3

Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	-0.5 to $+7.0$V
DC Input Voltage (V_{IN})	-1.5 to $V_{CC} + 1.5$V
DC Output Voltage (V_{OUT})	-0.5 to $V_{CC} + 0.5$V
Clamp Diode Current (I_{IK}, I_{OK})	± 20 mA
DC Output Current, per pin (I_{OUT})	± 25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	± 50 mA
Storage Temperature Range (T_{STG})	$-65°C$ to $+150°C$
Power Dissipation (P_D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T_L)	
(Soldering 10 seconds)	260°C

Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temp. Range (T_A)			
MM74HC	-40	$+85$	°C
MM54HC	-55	$+125$	°C
Input Rise or Fall Times			
(t_r, t_f) $\quad V_{CC} = 2.0$V		1000	ns
$V_{CC} = 4.5$V		500	ns
$V_{CC} = 6.0$V		400	ns

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V_{CC}	$T_A = 25°C$ Typ	$T_A = 25°C$ Guaranteed Limits	74HC $T_A = -40$ to 85°C	54HC $T_A = -55$ to 125°C	Units
V_{IH}	Minimum High Level Input Voltage		2.0V		1.5	1.5	1.5	V
			4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V_{IL}	Maximum Low Level Input Voltage**		2.0V		0.5	0.5	0.5	V
			4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V_{OH}	Minimum High Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL} $\|I_{OUT}\| \leq 20\ \mu A$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		$V_{IN} = V_{IH}$ or V_{IL} $\|I_{OUT}\| \leq 4.0$ mA	4.5V		3.98	3.84	3.7	V
		$\|I_{OUT}\| \leq 5.2$ mA	6.0V		5.48	5.34	5.2	V
V_{OL}	Maximum Low Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL} $\|I_{OUT}\| \leq 20\ \mu A$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL} $\|I_{OUT}\| \leq 4.0$ mA	4.5V	0.2	0.26	0.33	0.4	V
		$\|I_{OUT}\| \leq 5.2$ mA	6.0V	0.2	0.26	0.33	0.4	V
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		± 0.1	± 1.0	± 1.0	μA
I_{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0\ \mu A$	6.0V		4.0	40	80	μA

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

Note 4: For a power supply of 5V $\pm 10\%$ the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at $V_{CC} = 5.5$V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

**V_{IL} limits are currently tested at 20% of V_{CC}. The above V_{IL} specification (30% of V_{CC}) will be implemented no later than Q1, CY'89.

AC Electrical Characteristics $V_{CC} = 5V$, $T_A = 25°C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
f_{MAX}	Maximum Operating Frequency		50	30	MHz
t_{PHL}, t_{PLH}	Maximum Propagation Delay Clock to Q or $\overline{Q}$		16	21	ns
t_{PHL}, t_{PLH}	Maximum Propagation Delay Clear to Q or $\overline{Q}$		21	26	ns
t_{REM}	Minimum Removal Time, Clear to Clock		10	20	ns
t_s	Minimum Setup Time, J or K to Clock		14	20	ns
t_H	Minimum Hold Time J or K from Clock		-3	0	ns
t_W	Minimum Pulse Width, Clock or Clear		10	16	ns

AC Electrical Characteristics $C_L = 50$ pF, $t_r = t_f = 6$ ns (unless otherwise specified)

Symbol	Parameter	Conditions	V_{CC}	$T_A = 25°C$ Typ	$T_A = 25°C$ Guaranteed Limits	74HC $T_A = -40$ to $85°C$	54HC $T_A = -55$ to $125°C$	Units
f_{MAX}	Maximum Operating Frequency		2.0V	9	5	4	3	MHz
			4.5V	45	27	21	18	MHz
			6.0V	53	31	24	20	MHz
t_{PHL}, t_{PLH}	Maximum Propagation Delay Clock to Q or $\overline{Q}$		2.0V	70	126	160	185	ns
			4.5V	18	25	32	37	ns
			6.0V	16	21	27	32	ns
t_{PHL}, t_{PLH}	Maximum Propagation Delay Clear to Q or $\overline{Q}$		2.0V	126	155	194	250	ns
			4.5V	25	31	39	47	ns
			6.0V	21	26	32	40	ns
t_{REM}	Minimum Removal Time Clear to Clock		2.0V	55	100	125	150	ns
			4.5V	11	20	25	30	ns
			6.0V	9	17	21	25	ns
t_s	Minimum Setup Time J or K to Clock		2.0V	77	100	125	150	ns
			4.5V	15	20	25	30	ns
			6.0V	13	17	21	25	ns
t_H	Minimum Hold Time J or K to Clock		2.0V	-3	0	0	0	ns
			4.5V	-3	0	0	0	ns
			6.0V	-3	0	0	0	ns
t_W	Minimum Pulse Width Clear or Clock		2.0V	55	80	100	120	ns
			4.5V	11	16	20	24	ns
			6.0V	10	14	18	21	ns
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time		2.0V	30	75	95	110	ns
			4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
t_r, t_f	Maximum Input Rise and Fall Time		2.0V		1000	1000	1000	ns
			4.5V		500	500	500	ns
			6.0V		400	400	400	ns
C_{PD}	Power Dissipation Capacitance (Note 5)	(per flip-flop)		80				pF
C_{IN}	Maximum Input Capacitance			5	10	10	10	pF

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.
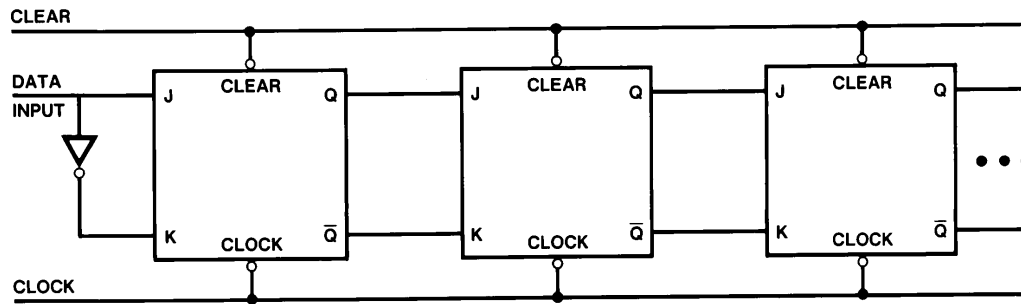
3

Typical Applications

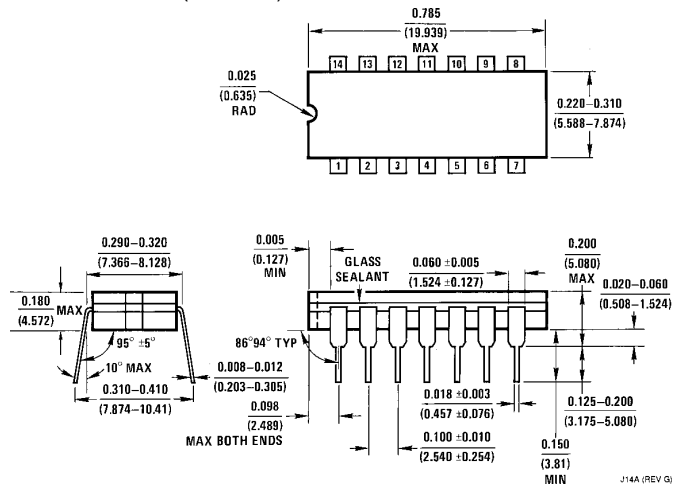## N Bit Binary Ripple Counter with Enable and Reset

COUNTER ENABLE

RESET

TO
NEXT BIT

CLOCK

BIT 3   BIT 2   LSB
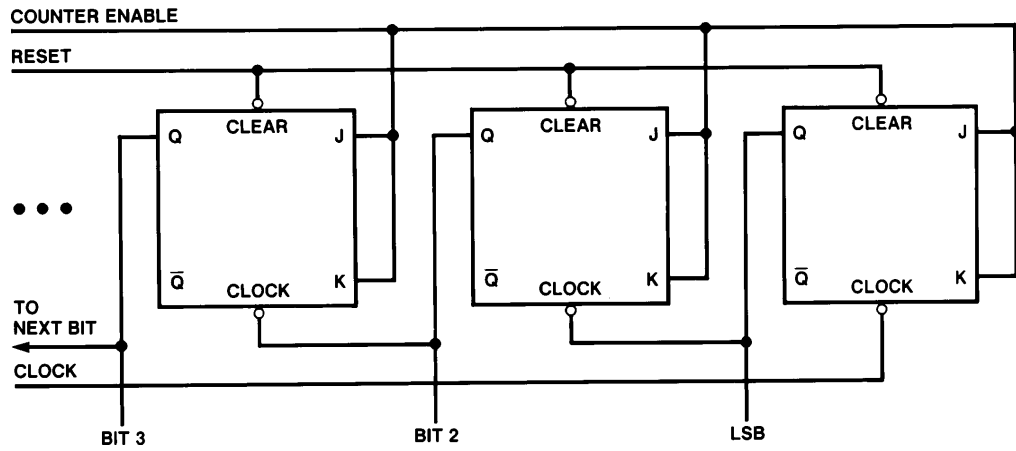
TL/F/5304–4

N Bit Shift Register with Clear

CLEAR

DATA
INPUT

CLOCK

TL/F/5304–5

4

Physical Dimensions inches (millimeters)

0.785
(19.939)
MAX

14 13 12 11 10 9 8

0.025
(0.635)
RAD

0.220−0.310
(5.588−7.874)

1 2 3 4 5 6 7

0.290−0.320
(7.366−8.128)

0.005
(0.127)
MIN

GLASS
SEALANT

0.060 ±0.005
(1.524 ±0.127)

0.200
(5.080)
MAX

0.020−0.060
(0.508−1.524)

0.180
(4.572) MAX

95° ±5°

86°94° TYP

10° MAX

0.008−0.012
(0.203−0.305)

0.310−0.410
(7.874−10.41)

0.098
(2.489)
MAX BOTH ENDS

0.018 ±0.003
(0.457 ±0.076)

0.100 ±0.010
(2.540 ±0.254)

0.125−0.200
(3.175−5.080)

0.150
(3.81)
MIN

J14A (REV G)

Ceramic Dual-In-Line Package (J)
Order Number MM54HC107J or MM74HC107J
NS Package Number J14A

5

Physical Dimensions inches (millimeters) (Continued)
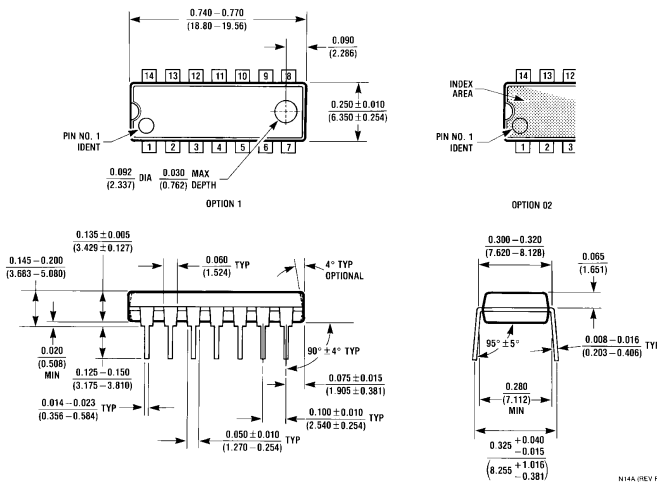
Molded Dual-In-Line Package (N)
Order Number MM74HC107N
NS Package Number N14A